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(12) United States Patent

Enomoto et al.

(54) SOUND PICKUP DEVICE

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(30) Foreign Application Priority Data

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(51) **Int. Cl.** *H04R 1/08* (20

(2006.01)

(52) U.S. Cl. CPC *H04R 1/08* (2013.01); *H04R 2430/00*

(58) Field of Classification Search

None

See application file for complete search history.

(10) Patent No.: US 12,395,772 B2

(45) **Date of Patent:** Aug. 19, 2025

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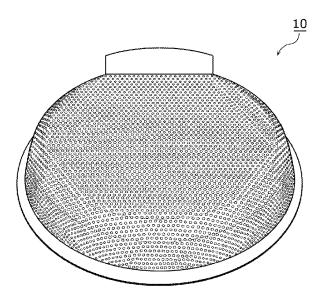
* cited by examiner

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(57) ABSTRACT

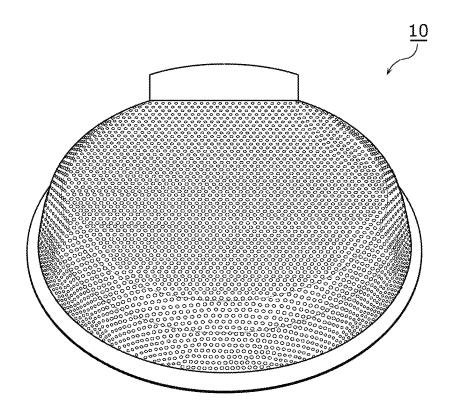
A sound pickup device includes microphone elements arranged three-dimensionally in a distributed manner. A total number of effective microphone pairs is greater than a total number of the microphone elements, the effective microphone pairs each being a combination of two microphone elements having a distance less than a distance D between each other. The distance D is represented by D=c/2f, where f represents a frequency of a target sound obtained from each of the microphone elements and c represents a velocity of the target sound. Any one of straight lines each of which connects the two microphone elements of a different one of the effective microphone pairs is not parallel to any other of the straight lines.

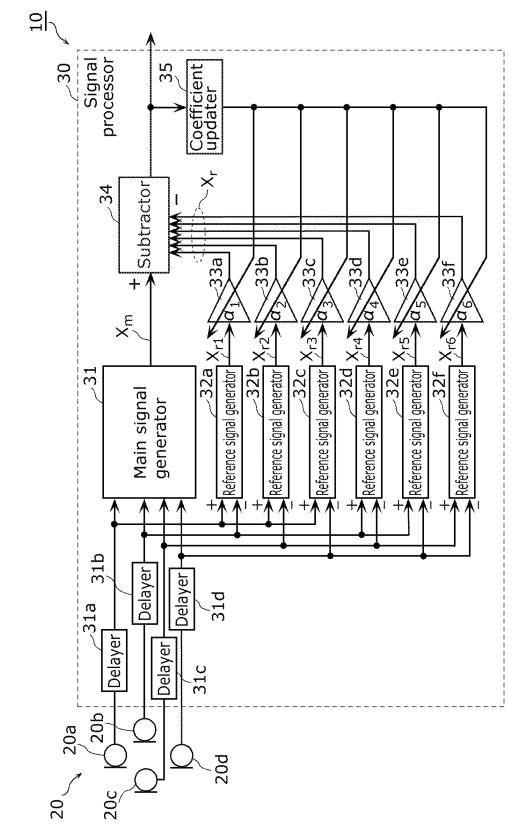
5 Claims, 23 Drawing Sheets



(2013.01)

FIG. 1





-1G. 2

Output signal Y Target sound Reference signal X_r Target sound Main signal X_{m} Target sound

FIG. 3

FIG. 4

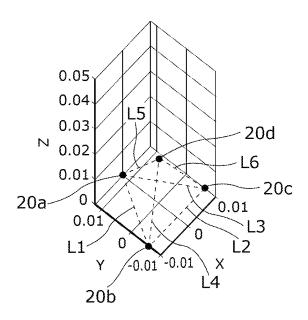


FIG. 5

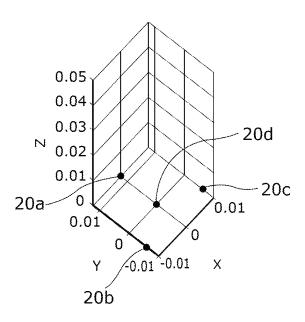


FIG. 6

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Microphone pair (20b, 20c)	30 deg. 120 90 60 150 00	330 210 (270 300)	0 -10 -20 -30 -40	60 deg.	(330 210) (330 330	0 -10 20 30 40	30 150 90 deg. 30 150 90 60 10 180 0	330 210 X X 330 740 270 300	0 -10 >20 -30 -40
Microphone pair (20a, 20c)	30 deg. 120 90 60 150 00	240 270 300	0 -10 -20 -30 -40	60 deg.) Sin (1) (1) (1) (1) (1) (1) (1) (1) (1) (1)	0 -10 -20 -30 -40	90 deg. 120 90 60 150	240 270 300	0 -10 >20 -30 -40
Microphone pair (20a, 20b)	30 deg. 120 90 60 150 00	330 210	0 -10 20 30 40	30 150 90 60 150 30 30 150 30 30 150 30 150 30 30 30 30 30 30 30 30 30 30 30 30 30		0 -10 -20 -30 -40	90 deg. 120 90 60 150 60	240 270 300	0 -10 20 30 40
Microphone paír (20d, 20c)	30 deg. 120 90 60 150 (150)	330 210 270 330	0 -10 -20 -30 -40	60 deg. 120 90 60 150 60	210 270 300	0 -10 -20 -30 -40	90 deg. 120 90 60 150 0 130	240 270 300	0 -10 -20 -30 -40
Microphone paír (20d, 20b)	30 deg. 120 90 60 150	330 210 240 270 300	0 -10 20 30 40	60 deg. 120 90 60 150 00 150	240 270 300	0 -10 -20 -30 -40	90 deg. 120 90 60 150 00 60	240 270 380	0 -10 -20 -30 -40
Microphone pair (20d, 20a)	30 deg. 120 90 60 150	180 210 240 270 300	0 - 10 >20 -30 -40	60 deg. 120 90 60 150	100 PM 10	0 -10 -20 -30 -40	90 deg. 120 90 60 150 60 180 60	240 270 300	0 -10 20 30 -40

FIG. 7

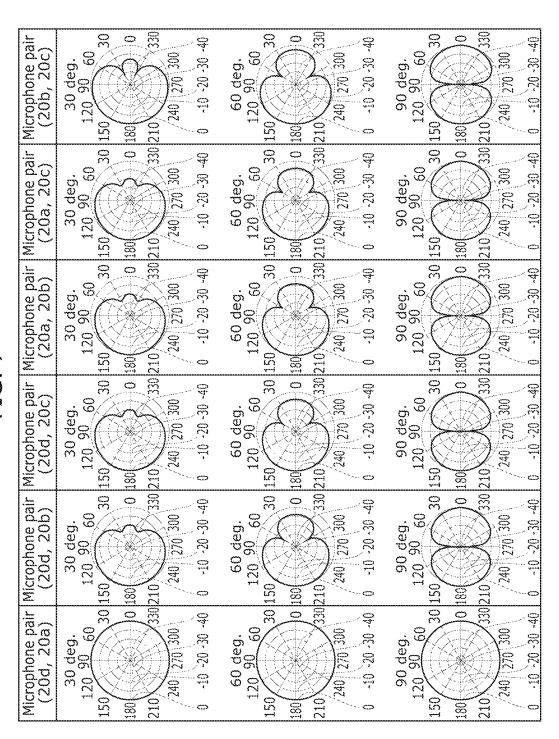
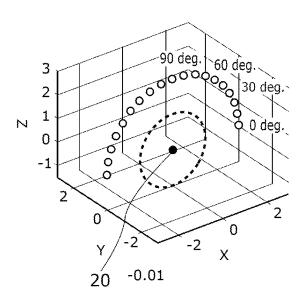


FIG. 8





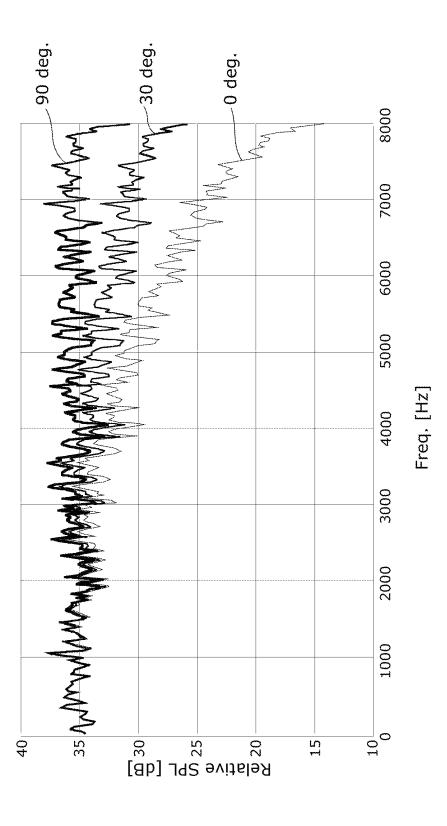
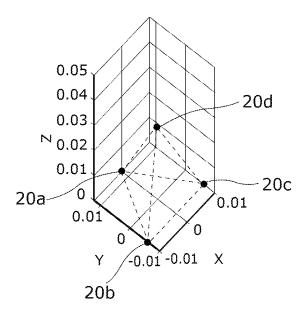


FIG. 10





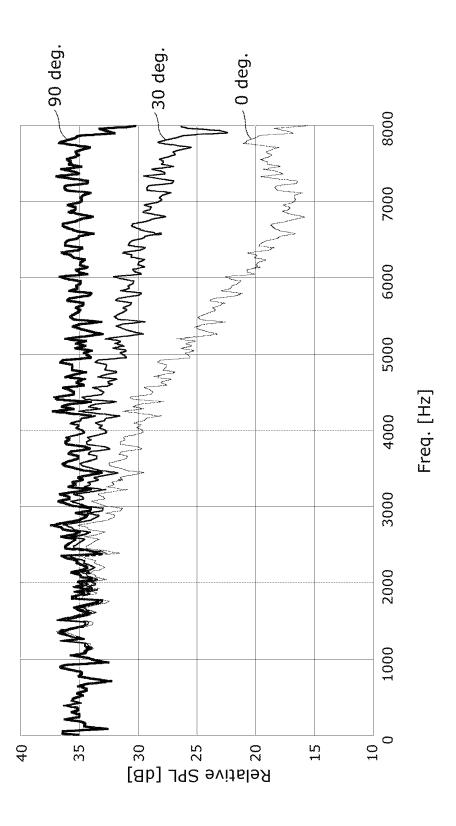


FIG. 12

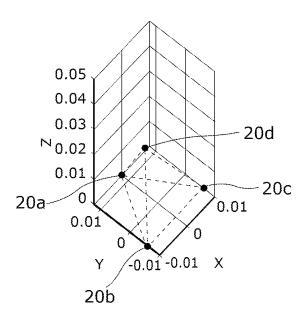


FIG. 13

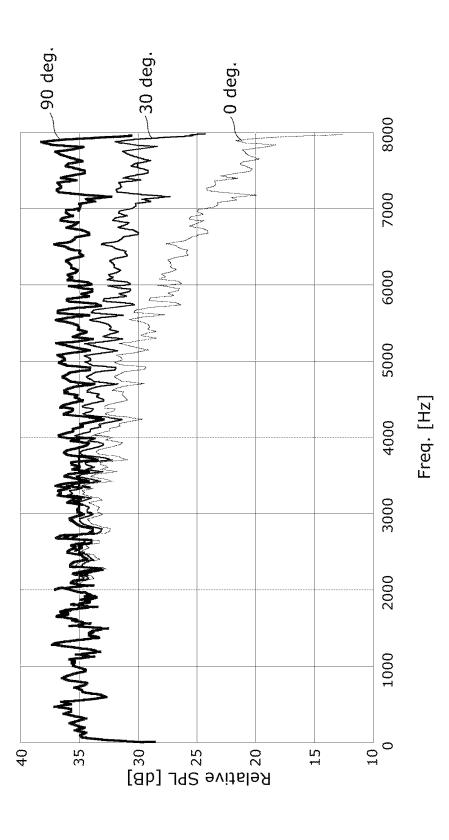


FIG. 14

Microphone pair (20b, 20c)	30 deg. 120 90 60			0 -10 -20 -30 -40	60 deg. 120 90 60 150 00 30	180	/ 240 270 300 0 -10 -20 -30 -40	90 deg.	150 50	210 270 300	0 -10 -20 -30 -40
Microphone pair (20a, 20c)	30 deg. 120 90 60			0 -10 -20 -30 -40	60 deg. 120 90 60 120 30 150 00 150	330 210	/240 <u> 270</u> (300) 0 -10 -20 -30 -40	90 deg.	30 150, 30 150,	330 210 7 7 330	0 -10 >20 -30 -40
Microphone pair (20a, 20b)	30 deg. 120_90_60	30 150		0 -10 20 30 40	60 deg.		/240 270 300 0 -10 -20 -30 -40	90 deg.		246 200 200 200 200 200 200 200 200 200 20	0 -10 20 30 40
		30 150	24 S2 S2	0 -10 -20 -30 -40	60 deg. 120 90 60 150 00 30	1806	/240 270 300 0 -10 -20 -30 -40	90 deg.	30 150 20 30 150 30 180 30 150	210 (270 300)	0 -10 -20 -30 -40
Microphone pair Microphone pair Microphone pair (20d, 20a) (20d, 20b) (20d, 20c)	30 deg. 120_90_60	30 150	85 SS	0 -10 -20 -30 -40	60 deg. 120 90 60 1 30 150 70 150	330/210	/240 270 300 0 -10 -20 -30 -40	90 deg.	30 150 60	330210 X 330 240 270 300	0 -10 -20 -30 -40
Microphone pair (20d, 20a)	30 deg. 120 90 60		00C 01Z 04Z	0 -10 -20 -30 -40	60 deg. 120 90 60 150 \ \ \ \ \ \ \ 30	1800	/240 <u>270 300</u> 0 -10 -20 -30 -40	v	150 60	210 330	0 -10 -20 -30 -40

FIG. 15

air Microphone pair (20b, 20c)	30 deg.	30 150 00 60	Testi Testi	330 210 240 330 330	`~~	60 deg.	30 150 90 60	0 1880	240 270 300	40 0 -10 20-30-40	90 deg.	30 150 90 60	330 210	/240 270 300	
Microphone pair (20a, 20c)	30 deg.	120 90 60	081	330 210 200	0 -10 -20 -30 -40	60 deg.	120 90 60	0 [80]	240 270 300	0 -10 20 30 40	90 deg.	30 150 90 60	330 210 V	/240 /270 300	- C
Microphone pair (20a, 20b)	30 deg.	120 90 60	180	330 Z12 OSC	0 -10 -20 -30 -40	60 deg.	120 90 60	0 180 0	25 25 35 35 SE	0 -10 -20 -30 -40	90 deg.	150 90 60	330 210 7 3330	/240 270 300	
Microphone pair (20d, 20c)	30 deg.	150 90 60		210/2012	0 -10 -20 -30 -40	60 deg.	120 90 60	1881	240 270 300	0 -10 -20 -30 -40	90 deg.	120 90 60		7240 270 300	200
Microphone pair (20d, 20b)	30 deg.	120 90 60 150 0 60	0 0 001	30210	0 -10 -20 -30 -40	60 deg.	150 90 60	0 1800	270 300	0 -10 -20 -30 -40	90 deg.	150 90 60	30/210	740 270 300	- 5
Microphone pair (20d, 20a)	30 deg.	150 90 60		210 200	0 -10 -20 -30 -40	60 deg.	120 90 60	180	240 270 300	0 -10 \20 -30 -40	90 deg.	120 90 60	210 () () () () () () ()	/240 270 300	

FIG. 16

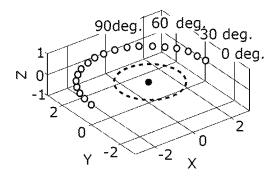


FIG. 17

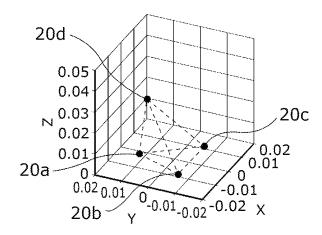


FIG. 18

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Microphone pair (20b, 20c)	30 deg.	120 90 60	0 1880	240 270 300	0 -10 -20 -30 -40	60 deg.	120 90 60	1881	240 270 300 300	0 -10 -20 -30 -40	90 deg.	120 90 60	0 1890	240 270 300	0 -10 -20 -30 -40
Microphone paír (20a, 20c)	30 deg.	150 90 60	0 [300 0	240 270 300	0 -10 -20 -30 -40	60 deg.	120 90 60		240 270 300	0 -10 -20 -30 -40	90 deg.	120 90 60 150 30	981	246 2770 380	0 -10 -20 -30 -40
Microphone pair (20a, 20b)	30 deg.	120 90 60 150 30	1880	7240 270 300	0 -10 20 30 40	60 deg.	150 90 60	081 081	240 2/1000	0 -10 -20 -30 -40	90 deg.	120 90 60 150 30	0 180	240 270 300	0 -10 -20 -30 -40
Microphone pair (20d, 20c)	30 deg.	150 90 60	1806	240 270 300	0 -10 >20 -30 -40	60 deg.	120 90 60 150 30	180 X	240 270 300	0 -10 20 30 -40	90 deg.	120 90 60	180	740 270 300	0 -10 -20 -30 -40
Microphone pair (20d, 20b)	30 deg.	150 90 60	1890	240 270 300	0 -10 20 30 -40	60 deg.	120 90 60		240 300 300	0 -10 -20 -30 -40	90 deg.	120 90 60	0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	240 270 300	0 -10 -20 -30 -40
Microphone pair (20d, 20a)	30 deg.	120 90 60 150 7 30	180	240 270 300	0 -10 20 30 -40	60 deg.	120 90 60		240 270 300 / Jan	0 -10 >20 -30 -40	90 deg.	120 90 60		240 270 300	0 -10 20 30 40

FIG. 19

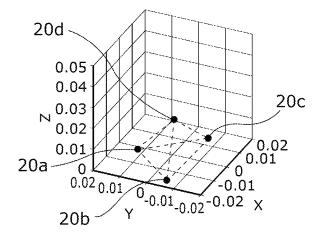


FIG. 20

Microphone pair (20b, 20c)	30 deg.	120 90 60	30 150 30	0 180 0	330 210 \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	/ 240 270 300	0 -10 -20 -30 -40	60 deg.	120 90 60	0£ 150 051 051 051 051 051 051 051 051 051		S Z .	7.240 270 300	0 -10 -20 -30 -40	90 deg.	120 90 60	150	180 180 0	× 2.1.	7.240 270 300	0 -10 >20 -30 -40
Microphone pair (20a, 20c)	30 deg.	120 90 60	150 20 20 20 20 20 20 20 20 20 20 20 20 20	180	Sec	7.240 270 300	0 -10 -20 -30 -40	60 deg.	120 90 60	150 30	1881		7.240 270 300	0 -10 20 30 40	90 deg.	120,90,60	150, 30		2017 2017	7.240 270 300	0 -10 >20 -30 -40
Microphone pair (20a, 20b)	30 deg.	120 90 60	150	180 () () () () () () () () () (7 240 270 300	0 -10 20 30 40	60 deg.	120 90 60	150			72/0 200	0 -10 20 -30 -40	90 deg.	120,90,60	150		2102/1/330	/ 240 270 300	0 -10 >20 -30 -40
Microphone pair (20d, 20c)	30 deg.	120 90 60	150 150 30	180		/ 240 270 300	0 -10 -20 -30 -40	60 deg.	120 90 60	150 30		وسيرين	7 240 270 300	0 -10 -20 -30 -40	90 deg.	120,90,60	150	0 7 9 081	210	/ 240 (270 (300)	0 -10 \20 -30 -40
Microphone pair (20d, 20b)	30 deg.	120 90 60	150	180		7.240 270 300	0 -10 -20 -30 -40	60 deg.	20 90 60	150 30			/ 240 (270 (300)	0 -10 -20 -30 -40	90 deg.	20,90,60	150			7.240 (270) 300	0 -10 -20 -30 -40
Microphone pair (20d, 20a)	30 deg.	20,90,60	150	180	DEE / 3330	7,240 270 300	0 -10 -20 -30 -40	60 deg.	20 90 60	150 30		330	/ 240 270 300	0 -10 -20 -30 -40	90 deg.	20,90,60	150 30		330	7.240 270 300	0 -10 >20 -30 -40

FIG. 21

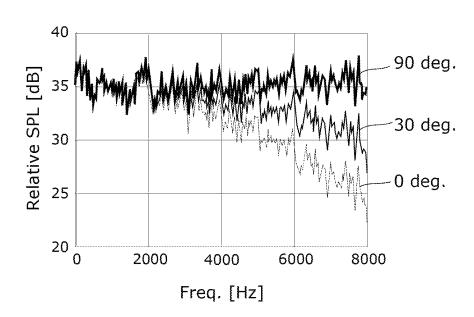


FIG. 22

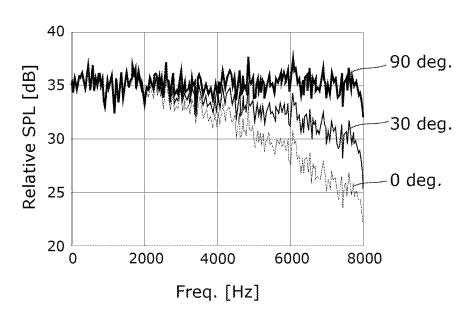


FIG. 23

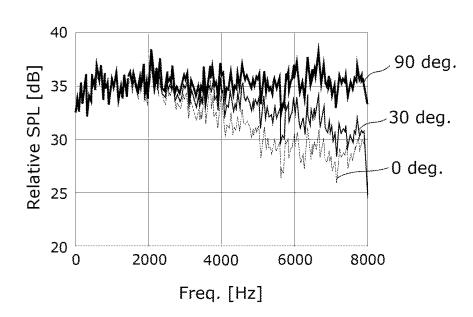


FIG. 24

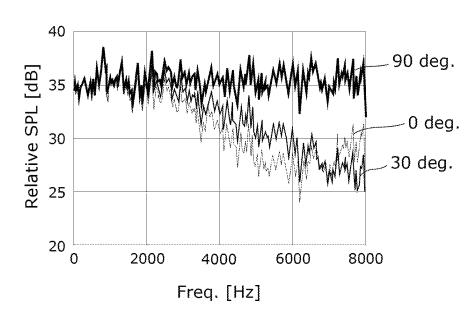


FIG. 25

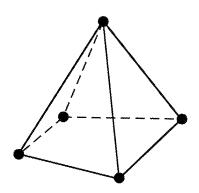
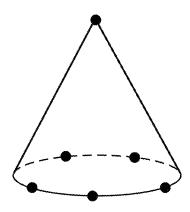


FIG. 26



1 SOUND PICKUP DEVICE

CROSS REFERENCE TO RELATED APPLICATIONS

This is a continuation application of PCT International Application No. PCT/JP2021/037473 filed on Oct. 8, 2021, designating the United States of America, which is based on and claims priority of Japanese Patent Application No. 2020-187537 filed on Nov. 10, 2020. The entire disclosures of the above-identified applications, including the specifications, drawings and claims are incorporated herein by reference in their entirety.

FIELD

The present disclosure relates to a sound pickup device for beamforming.

BACKGROUND

Beamforming is a technique of generating a signal emphasizing a sound from a target sound direction by using sound signals obtained from microphone elements. Non-Patent Literature (NPL) 1 discloses a generalized sidelobe canceller (GSC) as an example of a beamformer using adaptive filters.

CITATION LIST

Non-Patent Literature

NPL1: L. Griffiths and C. W. Jim, "An alternative approach to linearly constrained adaptive beamforming", IEEE Trans. Antennas Propagation, vol. AP-30, pp 27-34, January 1982.

SUMMARY

Technical Problem

The present disclosure provides a sound pickup device 45 arrangement example 3 of microphone elements. that effectively reduces sound other than a target sound.

Solution to Problem

A sound pickup device according to an aspect of the present disclosure includes a plurality of microphone elements that are arranged three-dimensionally in a distributed manner, wherein among microphone pairs each of which is a different combination of two microphone elements of the 55 plurality of microphone elements, a total number of effective microphone pairs is greater than a total number of the plurality of microphone elements, the effective microphone pairs each being a combination of two microphone elements the distance D is represented by D=c/2f, where f represents a frequency of a target sound obtained from the plurality of microphone elements and c represents a velocity of the target sound, and any one of straight lines each of which connects the two microphone elements of a different one of 65 the effective microphone pairs is not parallel to any other of the straight lines.

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Advantageous Effects

A sound pickup device according to an aspect of the present disclosure can effectively reduce sound other than a target sound.

BRIEF DESCRIPTION OF DRAWINGS

- FIG. 1 is an external perspective view of a sound pickup 10 device according to an embodiment.
 - FIG. 2 is a block diagram illustrating a functional configuration of the sound pickup device according to the embodiment.
- FIG. 3 is a diagram schematically illustrating a calcula-15 tion formula of an output signal based on sensitivity characteristics of a main signal, a reference signal, and the output
 - FIG. 4 is a diagram illustrating three-dimensional arrangement example 1 of microphone elements.
 - FIG. 5 is a diagram illustrating a planar arrangement example of microphone elements.
 - FIG. 6 is a diagram illustrating sensitivity characteristics, in a direction along an XZ plane, of reference signals that are generated by a sound pickup device employing three-dimensional arrangement example 1.
 - FIG. 7 is a diagram illustrating sensitivity characteristics, in the direction along the XZ plane, of reference signals that are generated by a sound pickup device employing the planar arrangement example.
 - FIG. 8 is a diagram for describing a method for calculating sensitivity characteristics shown in FIG. 6 and FIG. 7.
 - FIG. 9 is a diagram illustrating frequency responses of a main signal that is generated by the sound pickup device employing three-dimensional arrangement example 1 and of which the target sound direction is a 90° direction along the
 - FIG. 10 is a diagram illustrating three-dimensional arrangement example 2 of microphone elements.
- FIG. 11 is a diagram illustrating frequency responses of a 40 main signal that is generated by a sound pickup device employing three-dimensional arrangement example 2 and of which the target sound direction is the 90° direction along the XZ plane.
 - FIG. 12 is a diagram illustrating three-dimensional
- FIG. 13 is a diagram illustrating frequency responses of a main signal that is generated by a sound pickup device employing three-dimensional arrangement example 3 and of which the target sound direction is the 90° direction along 50 the XZ plane.
 - FIG. 14 is a diagram illustrating sensitivity characteristics, in a direction along an XY plane, of reference signals that are generated by the sound pickup device employing three-dimensional arrangement example 1.
 - FIG. 15 is a diagram illustrating sensitivity characteristics, in the direction along the XY plane, of reference signals that are generated by the sound pickup device employing the planar arrangement example.
- FIG. 16 is a diagram for describing a method for calcuhaving a distance less than a distance D between each other, 60 lating sensitivity characteristics shown in FIG. 14 and FIG.
 - FIG. 17 is a diagram illustrating three-dimensional arrangement example 4 of microphone elements.
 - FIG. 18 is a diagram illustrating sensitivity characteristics, in the direction along the XY plane, of reference signals that are generated by a sound pickup device employing three-dimensional arrangement example 4.

FIG. 19 is a diagram illustrating three-dimensional arrangement example 5 of microphone elements.

FIG. **20** is a diagram illustrating sensitivity characteristics, in the direction along the XY plane, of reference signals that are generated by a sound pickup device employing ⁵ three-dimensional arrangement example **5**.

FIG. 21 is a diagram illustrating frequency responses of a main signal that is generated by the sound pickup device employing the planar arrangement example and of which the target sound direction is a 90° direction along the XY plane.

FIG. 22 is a diagram illustrating frequency responses of a main signal that is generated by the sound pickup device employing three-dimensional arrangement example 1 and of which the target sound direction is the 90° direction along the XY plane.

FIG. 23 is a diagram illustrating frequency responses of a main signal that is generated by the sound pickup device employing three-dimensional arrangement example 4 and of which the target sound direction is the 90° direction along the XY plane.

FIG. 24 is a diagram illustrating frequency responses of a main signal that is generated by the sound pickup device employing three-dimensional arrangement example 5 and of which the target sound direction is the 90° direction along the XY plane.

FIG. 25 is a diagram illustrating an example where microphone elements are arranged at the vertices of a quadrangular pyramid.

FIG. **26** is a diagram illustrating an example where microphone elements are arranged at the apex and the ³⁰ circumference of the bottom of a cone.

DESCRIPTION OF EMBODIMENT

Hereinafter, an embodiment will be described with reference to the Drawings. The embodiment described below shows a general or specific example. The numerical values, shapes, materials, constituent elements, the arrangement and connection of the constituent elements, etc. shown in the embodiment below are mere examples, and therefore do not limit the scope of the present disclosure. Moreover, among the constituent elements in the embodiment below, constituent elements not recited in any one of the independent claims defining the broadest concept are described as arbitrary constituent elements.

Furthermore, the Drawings are schematic drawings and are not necessarily precise depictions. Furthermore, elements that are essentially the same share the same reference signs in the respective Drawings, and overlapping explanations thereof may be omitted or simplified.

Furthermore, in the embodiment below, when a sound from a certain direction is a main target to be output by a sound pickup device, the certain direction is referred to as a target sound direction and the sound is referred to as a target sound. Furthermore, sound other than the target sound may be referred to as noise.

Signals obtain Delayers 31a to microphone elements sound direction output signals.

Main signal

Embodiment

(Configuration of Sound Pickup Device)

Hereinafter, a configuration of a sound pickup device according to an embodiment will be described with reference to FIG. 1 and FIG. 2. FIG. 1 is an external perspective view of the sound pickup device according to the embodiment. FIG. 2 is a block diagram illustrating a functional configuration of the sound pickup device according to the embodiment.

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As illustrated in FIG. 1, sound pickup device 10 according to the embodiment is a substantially disk-shaped device. For example, sound pickup device 10 is placed on a desk and used for picking up voice during a teleconference or the like. It should be noted that the shape of sound pickup device 10 is not limited to a substantially disk shape. As illustrated in FIG. 2, sound pickup device 10 includes microphone elements 20a to 20d and signal processor 30, inside the body as illustrated in FIG. 1. Microphone elements 20a to 20d constitute microphone array 20. It should be noted that sound pickup device 10 does not necessarily include signal processor 30, and signal processor 30 may be implemented as a separate device from sound pickup device 10.

Microphone elements 20a to 20d constitute microphone array for generating main signal X_m and reference signals X_{r1} to X_{r6} that are used for beamforming. In other words, microphone elements 20a to 20d are used for enabling signal processor 30 that is a beamformer to obtain sound signals. Microphone elements 20a to 20d are arranged on the same plane. Although sound pickup device includes four microphone elements 20a to 20d in the embodiment, the total number of microphone elements is not particularly limited to this example. The total number of microphone elements may be an even number or an odd number. For example, sound pickup device 10 may include four or more microphone elements.

Signal processor 30 is a beamformer that performs beamforming using sound signals obtained from microphone elements 20a to 20d. Beamforming by signal processor 30 is signal processing for forming a directivity so that sensitivity to a target sound direction is ensured and noise is at a dead angle. In other words, according to beamforming by signal processor 30, noise coming from any direction other than the target sound direction is reduced. Although each of microphone elements 20a to 20d is an omnidirectional microphone element, sound pickup device 10 achieves high sensitivity to the target sound direction through beamforming by signal processor 30.

More specifically, signal processor 30 has a configuration similar to that of a generalized sidelobe canceller. For example, signal processor 30 is implemented as a processor such as a digital signal processor (DSP) but may also be implemented as a microcomputer or a circuit. Moreover, signal processor 30 may be implemented as a combination of two or more of a processor, a microcomputer, and a circuit. Signal processor 30 includes delayers 31a to 31d, main signal generator 31, reference signal generators 32a to 32f, adaptive filters 33a to 33f, subtractor 34, and coefficient updater 35.

Delayers 31a to 31d correspond one-to-one to sound signals obtained from microphone elements 20a to 20d. Delayers 31a to 31d delay the sound signals obtained from microphone elements 20a to 20d according to the target sound direction, and output the delayed sound signals as output signals.

Main signal generator 31 is an example of a first signal generator, and generates main signal X_m by adding up sound signals that have been obtained from microphone elements 20a to 20d and delayed by delayers 31a to 31d, respectively, according to the target sound direction. Main signal X_m is an example of a first signal.

Each of reference signal generators 32a to 32f is an example of a second signal generator. Reference signal generators 32a to 32f correspond one-to-one to six microphone pairs each of which is a different combination of two microphone elements of microphone elements 20a to 20d. One reference signal generator generates a reference signal

by performing subtraction between two sound signals that have been obtained from two microphone elements of a corresponding one of the microphone pairs and delayed by corresponding two of delayers 31a to 31d according to the target sound direction. Each of reference signals X_{r1} to X_{r6} 5 is an example of a second signal.

Moreover, adaptive filters 33a to 33f correspond one-to-one to reference signal generators 32a to 32f. Adaptive filters 33a to 33f apply filter coefficients α_1 to α_6 to reference signals X_{r1} to X_{r6} generated by reference signal generators 10 32a to 32f, respectively.

For example, reference signal generator 32a generates reference signal X_{r1} by performing subtraction between sound signals (output signals from delayers 31a and 31b) that have been obtained from microphone elements 20a and 20b and delayed by delayers 31a and 31b, respectively, according to the target sound direction. Adaptive filter 33a applies filter coefficient α_1 to reference signal X_{r1} .

Similarly, reference signal generator 32b generates reference signal X_{r2} by performing subtraction between sound signals (output signals from delayers 31a and 31c) that have been obtained from microphone elements 20a and 20c and delayed by delayers 31a and 31c, respectively, according to the target sound direction. Adaptive filter 33b applies filter coefficient α_2 to reference signal X_{r2} .

Reference signal generator 32c generates reference signal X_{r3} by performing subtraction between sound signals (output signals from delayers 31a and 31d) that have been obtained from microphone elements 20a and 20d and delayed by delayers 31a and 31d, respectively, according to 30 the target sound direction. Adaptive filter 33c applies filter coefficient α_3 to reference signal X_{r3} .

Reference signal generator 32d generates reference signal X_{r4} by performing subtraction between sound signals (output signals from delayers 31b and 31c) that have been 35 obtained from microphone elements 20b and 20c and delayed by delayers 31b and 31c, respectively, according to the target sound direction. Adaptive filter 33d applies filter coefficient α_4 to reference signal X_{r4} .

Reference signal generator 32e generates reference signal 40 X_{r5} by performing subtraction between sound signals (output signals from delayers 31b and 31d) that have been obtained from microphone elements 20b and 20d and delayed by delayers 31b and 31d, respectively, according to the target sound direction. Adaptive filter 33e applies filter 45 coefficient α_5 to reference signal X_{r5} .

Reference signal generator 32f generates reference signal X_{r6} by performing subtraction between sound signals (output signals from delayers 31c and 31d) that have been obtained from microphone elements 20c and 20d and 50 delayed by delayers 31c and 31d, respectively, according to the target sound direction. Adaptive filter 33f applies filter coefficient α_6 to reference signal X_{r6} .

Subtractor **34** subtracts, from main signal X_m generated, reference signals X_{r1} to X_{r6} to which filter coefficients α_1 to α_6 have been applied. Output signal Y obtained by the subtraction is represented by Formula 1 below. Output signal Y is an example of a third signal. In Formula 1, n represents the number of microphone pairs. Accordingly, n is a natural number, and n is six (n=6) in sound pickup device **10**.

$$Y=X_m-\Sigma_{k=1}{}^n\alpha_kX_{rk}$$
 (Formula 1)

Coefficient updater **35** updates filter coefficients α_1 to α_6 , 65 based on output signal Y obtained through the subtraction by subtractor **34**.

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FIG. 3 is a diagram schematically illustrating Formula 1 based on sensitivity characteristics of main signal X_m , reference signal X_r , and output signal Y. It should be noted that reference signal X_r represents the total of reference signals X_{r1} to X_{r6} to which filter coefficients α_1 to α_6 have been applied $(\alpha_1X_{r1}+\alpha_2X_{r2}+\alpha_3X_{r3}+\alpha_4X_{r4}+\alpha_5X_{r5}+\alpha_6X_{r6})$. The sensitivity characteristic is, in other words, directivity.

As illustrated in FIG. 3, main signal X_m has high sensitivity to all directions. In contrast, reference signal X_r has low sensitivity to the target sound direction due to adaptive filters 33a to 33f and coefficient updater 35. Accordingly, output signal Y that is obtained by subtracting reference signal X_r from main signal X_m has high sensitivity to the target sound direction. It should be noted that the target sound direction is, in other words, a beam direction. (Arrangement of Microphone Elements)

In sound pickup device 10, signal processor 30 can change a beam direction in output signal Y. For example, sound pickup device includes a user interface such as a touch screen or an operation button, and signal processor 30 changes the beam direction based on operation by a user through the user interface. Alternatively, signal processor 30 automatically changes the beam direction by detecting a sound volume or the like.

When signal processor 30 performs beamforming with a variable beam direction as above, sensitivity to directions other than the beam direction needs to be reduced as much as possible in output signal Y, whichever direction the beam direction is. Therefore, in sound pickup device 10, the arrangement of microphone elements 20a to 20d is determined in order to ensure such performance.

First, in sound pickup device 10, the total number of effective microphone pairs is greater than the total number of microphone elements 20a to 20d. Here, among microphone pairs each of which is a different combination of two microphone elements of microphone elements 20a to 20d, an effective microphone pair is a microphone pair in which a distance between the two microphone elements is less than distance D. Distance D is represented by D=c/2f, where f represents a frequency of a target sound obtained from microphone elements 20a to 20d and c represents a velocity of the target sound. In sound pickup device 10, the total number of the effective microphone pairs is six and the total number of the microphone elements is four.

It should be noted that distance D varies depending on the frequency of the target sound. For example, when the frequency of the target sound is 8 kHz and the velocity of the target sound is c=34000 cm/s, distance D is 2.125 cm. Moreover, when the frequency of the target sound is 4 kHz and the velocity of the target sound is c=34000 cm/s, distance D is 4.25 cm.

In some cases, a reference signal that is calculated using a noneffective microphone pair in which the distance between the two microphone elements is greater than or equal to distance D does not have a sensitivity characteristic that is assumed from the arrangement of the noneffective microphone pair, due to occurrence of aliasing in signal processing or the like. In other words, a reference signal that is calculated using the noneffective microphone pair may have an unexpected sensitivity characteristic, and therefore generation of highly accurate output signal Y may be hindered. In sound pickup device 10, generation of highly accurate output signal Y is achieved since the total number of the effective microphone pairs is greater than the total number of microphone elements 20a to 20d.

It should be noted that all of the microphone pairs obtainable from microphone elements 20a to 20d are the

effective microphone pairs in sound pickup device 10. Accordingly, the total number of the microphone pairs obtainable from microphone elements 20a to 20d is equal to the total number of the effective microphone pairs. However, there may be a case where some of the microphone pairs obtainable from microphone elements 20a to 20d are not the effective microphone pairs.

Moreover, microphone elements **20***a* to **20***d* are arranged three-dimensionally in a distributed manner. FIG. **4** is a diagram illustrating three-dimensional arrangement example **1** of microphone elements **20***a* to **20***d*. In FIG. **4**, the unit of the numerical values shown on the X-axis, the Y-axis, and the Z-axis is meter.

In three-dimensional arrangement example 1 in FIG. 4, microphone elements 20a to 20d are arranged at the vertices of a regular tetrahedron with a side length of approximately 2.1 cm (0.021 in the coordinates in FIG. 4). Specifically, microphone elements 20a to 20c are located on the XY plane where Z=0. The coordinates of microphone element 20d are 20 (0, 0, Z1, where Z1=approximately 0.0171) and microphone element 20d is located on the positive side of the Z-axis direction with respect to the XY plane where Z=0. It should be noted that the side length of 2.1 cm of the regular tetrahedron is determined assuming a half wave length of a 25 frequency of 8 kHz.

In three-dimensional arrangement example 1, any one of straight lines each of which connects the two microphone elements of a different one of the effective microphone pairs is not parallel to any other of the straight lines. Specifically, 30 in FIG. 4, straight line (line segment) L1 illustrated by a broken line is not parallel to any other straight lines L2 to L6. The same applies to straight lines L2 to L6. In other words, all of the straight lines each of which connects the two microphone elements of a different one of the effective 35 microphone pairs are not parallel to one another. (Sensitivity Characteristic of Reference Signal 1)

As illustrated in FIG. 4, when microphone elements 20a to 20d are arranged three-dimensionally in a distributed manner, variations of sensitivity characteristics of reference 40 signals are increased as compared to when microphone elements 20a to 20d are arranged on the same plane. Hereinafter, sensitivity characteristics of reference signals achieved by three-dimensional arrangement example 1 will be described. First, a planar arrangement example, which is 45 to be compared with three-dimensional arrangement example 1, will be described. FIG. 5 is a diagram illustrating the planar arrangement example of microphone elements 20a to 20d. In FIG. 5, the unit of the numerical values shown on the X-axis, the Y-axis, and the Z-axis is meter.

In the planar arrangement example in FIG. 5, microphone elements 20a to 20d are located on the XY plane where Z=0. Specifically, the arrangement of microphone elements 20a to 20c is the same as that in three-dimensional arrangement example 1 but microphone element 20d has coordinates of 55 (0, 0, 0). Accordingly, microphone elements 20a to 20d are arranged on the same plane in the planar arrangement example.

FIG. 6 is a diagram illustrating sensitivity characteristics, in a direction along the XZ plane, of reference signals that 60 are generated by sound pickup device 10 employing three-dimensional arrangement example 1. FIG. 7 is a diagram illustrating sensitivity characteristics, in the direction along the XZ plane, of reference signals that are generated by sound pickup device 10 employing the planar arrangement 65 example. FIG. 8 is a diagram for describing a method for calculating sensitivity characteristics shown in FIG. 6 and

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FIG. 7. In FIG. 8, the unit of the numerical values shown on the X-axis, the Y-axis, and the Z-axis is meter.

In each of FIG. 6 and FIG. 7, each of six columns shows sensitivity characteristics of a reference signal generated using a microphone pair. It should be noted that the sensitivity characteristic is, in other words, a directivity pattern.

For example, in each of FIG. 6 and FIG. 7, the leftmost column among the six columns shows sensitivity characteristics of a reference signal (corresponding to reference signal X_{r3} in FIG. 2) that is generated using a microphone pair of microphone element 20d and microphone element 20a. The second column from the left shows sensitivity characteristics of a reference signal (corresponding to reference signal X_{r5} in FIG. 2) that is generated using a microphone pair of microphone element 20d and microphone element 20b. The third column from the left shows sensitivity characteristics of a reference signal (corresponding to reference signal X_{r6} in FIG. 2) that is generated using a microphone pair of microphone element 20d and microphone element 20c.

The fourth column from the left shows sensitivity characteristics of a reference signal (corresponding to reference signal X_{r1} in FIG. 2) that is generated using a microphone pair of microphone element 20a and microphone element 20b. The fifth column from the left shows sensitivity characteristics of a reference signal (corresponding to reference signal X_{r2} in FIG. 2) that is generated using a microphone pair of microphone element 20a and microphone element 20c. The sixth column from the left shows sensitivity characteristics of a reference signal (corresponding to reference signal X_{r4} in FIG. 2) that is generated using a microphone pair of microphone element 20b and microphone element 20c.

Three sensitivity characteristics are illustrated in each of the six columns. The three sensitivity characteristics include a sensitivity characteristic of the reference signal that has a dead angle in a 90° direction, a sensitivity characteristic of the reference signal that has a dead angle in a 60° direction, and a sensitivity characteristic of the reference signal that has a dead angle in a 30° direction. Here, as illustrated by white circles in FIG. 8, the 90° direction is the positive Z-axis direction, and the 60° direction is a direction shifted by 30° from the positive Z-axis direction along the XZ plane. The 30° direction is a direction shifted by 60° from the positive Z-axis direction along the XZ plane. It should be noted that, as illustrated by a broken line in FIG. 8, the sensitivity characteristics shown in FIG. 6 and FIG. 7 are sensitivity characteristics for a sound at a position (illustrated by the broken line in FIG. 8) 1.5 m away from microphone array 20 (a collection of microphone elements 50 **20***a* to **20***d*).

As described above with reference to FIG. 4 and FIG. 5, only the position of microphone element 20d is different between three-dimensional arrangement example 1 and the planar arrangement example. Accordingly, as shown in the three columns in the right half of each of FIG. 6 and FIG. 7, sensitivity characteristics achieved by microphone pairs each of which is a different combination of two of microphone elements 20a to 20c are not different between three-dimensional arrangement example 1 and the planar arrangement example.

In contrast, as shown in the three columns in the left half of each of FIG. 6 and FIG. 7, sensitivity characteristics of microphone pairs each of which includes microphone element 20d are more varied in three-dimensional arrangement example 1 (FIG. 6) than in the planar arrangement example (FIG. 7). In other words, when microphone elements 20a to 20d are arranged three-dimensionally in a distributed man-

ner, variations of sensitivity characteristics of reference signals can be increased as compared to when microphone elements **20***a* to **20***d* are arranged on the same plane. Wide variations of sensitivity characteristics are advantageous for a noise reduction algorithm based on a generalized sidelobe 5 canceller, which is executed by signal processor **30**. When variations of sensitivity characteristics of reference signals are increased, sound pickup device **10** can reduce noise from various directions. Accordingly, sound pickup device **10** can effectively reduce sound other than a target sound.

(Frequency Response of Main Signal **1**)

Next, frequency responses, in a direction along the XZ plane, of a main signal that is generated by sound pickup device 10 employing three-dimensional arrangement example 1 will be described. FIG. 9 is a diagram illustrating 15 frequency responses of a main signal of which the target sound direction is the 90° direction along the XZ plane. In FIG. 9, a frequency response in the 90° direction, and a frequency response in a 0° direction of the main signal are illustrated, 20 and the target sound direction of the main signal is the 90° direction. In FIG. 9, the vertical axis indicates sound pressure level (SPL) and the horizontal axis indicates frequency.

As illustrated in FIG. 9, in the frequency response in the 90° direction of the main signal of which the target sound 25 direction is the 90° direction, the sound pressure level is generally flat in a frequency band of from 0 to 8 kHz. In contrast, in the frequency response in the 30° direction of the main signal, the sound pressure level is attenuated in a high frequency band. Moreover, in the frequency response in the 30° direction of the main signal, the sound pressure level is further attenuated in the high frequency band than that in the frequency response in the 30° direction of the main signal.

As above, sound pickup device 10 employing threedimensional arrangement example 1 can generate a main 35 signal having a directivity in a target sound direction (90° direction).

Here, the inventors attempted to improve the directivity of the main signal by adjusting the position of microphone element **20***d* in three-dimensional arrangement example **1**. 40 Specifically, the inventors have calculated frequency responses of a main signal in each of three-dimensional arrangement example **2** and three-dimensional arrangement example **3**.

First, three-dimensional arrangement example 2 will be 45 described. FIG. 10 is a diagram illustrating three-dimensional arrangement example 2 of microphone elements 20a to 20d. FIG. 11 is a diagram illustrating frequency responses of a main signal that is generated by sound pickup device 10 employing three-dimensional arrangement example 2 and of 50 which the target sound direction is the 90° direction along the XZ plane. In FIG. 11, a frequency response in the 90° direction, and a frequency response in the 0° direction of the main signal are illustrated, and the target sound direction of the main signal 55 is the 90° direction. In FIG. 11, the vertical axis indicates sound pressure level and the horizontal axis indicates frequency.

In three-dimensional arrangement example 2 in FIG. 10, the arrangement of microphone elements 20a to 20c is the 60 same as that in three-dimensional arrangement example 1. Microphone element 20d is located on the positive side of the Z-axis direction with respect to the position of microphone element 20d in three-dimensional arrangement example 1, and the coordinates of microphone element 20d 65 are $(0, 0, 1.5 \times Z1)$. In other words, in three-dimensional arrangement example 2, the position (height) of microphone

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element 20d with respect to the XY plane is 1.5 times higher than that in three-dimensional arrangement example 1. It should be noted that, in three-dimensional arrangement example 2, each of the distance between microphone element 20d and microphone element 20d, the distance between microphone element 20d and 20b, and the distance between microphone element 20d and 20c is approximately 2.9 cm (0.029) in the coordinates in FIG. 10).

In FIG. 11, the main signal is generated by sound pickup device 10 employing three-dimensional arrangement example 2, and the target sound direction of the main signal is the 90° direction. As illustrated in FIG. 11, in the frequency response in the 90° direction of the main signal, the sound pressure level is generally flat in a frequency band of from 0 to 8 kHz. In the frequency response in the 30° direction of the main signal when three-dimensional arrangement example 2 is employed, the sound pressure level is attenuated in a high frequency band; however, the frequency at which the sound pressure level starts to be attenuated is lower than the frequency at which the sound pressure level starts to be attenuated when three-dimensional arrangement example 1 is employed. Similarly, in the frequency response in the 0° direction of the main signal when three-dimensional arrangement example 2 is employed, the sound pressure level is attenuated in the high frequency band; however, the frequency at which the sound pressure level starts to be attenuated is lower than the frequency at which the sound pressure level starts to be attenuated when three-dimensional arrangement example 1 is employed. Accordingly, sound pickup device 10 employing threedimensional arrangement example 2 can generate a main signal of which the sound pressure level in a direction other than the target sound direction starts to be attenuated at a frequency lower than the frequency at which the sound pressure level starts to be attenuated in three-dimensional arrangement example 1. In other words, sound pickup device 10 employing three-dimensional arrangement example 2 can generate a main signal having a sharp directivity especially in a high frequency band.

Next, three-dimensional arrangement example 3 will be described. FIG. 12 is a diagram illustrating three-dimensional arrangement example 3 of microphone elements 20a to 20d. FIG. 13 is a diagram illustrating frequency responses of a main signal that is generated by sound pickup device 10 employing three-dimensional arrangement example 3 and of which the target sound direction is the 90° direction along the XZ plane. In FIG. 13, a frequency response in the 90° direction, and a frequency response in the 0° direction of the main signal are illustrated, and the target sound direction of the main signal is the 90° direction. In FIG. 13, the vertical axis indicates sound pressure level and the horizontal axis indicates frequency.

In three-dimensional arrangement example 3 in FIG. 12, the arrangement of microphone elements 20a to 20c is the same as that in three-dimensional arrangement example 1. Microphone element 20d is located on the positive side of the Y-axis direction with respect to the position of microphone element 20d in three-dimensional arrangement example 1, and the coordinates of microphone element 20d are (0, Y1, Z1). In three-dimensional arrangement example 3, the distance between microphone element 20d and microphone element 20a is approximately 1.9 cm (0.019) in the coordinates in FIG. 12). In three-dimensional arrangement example 3, each of the distance between microphone element 20d and microphone element 20d and microphone element 20d and the distance

between microphone element 20d and microphone element 20c is approximately 2.3 cm (0.023 in the coordinates in FIG. 12).

In FIG. 13, the main signal is generated by sound pickup device 10 employing three-dimensional arrangement example 3, and the target sound direction of the main signal is the 90° direction. As illustrated in FIG. 13, the frequency response in the 90° direction, the frequency response in the 30° direction, and the frequency response in the 0° direction of the main signal are similar to those in three-dimensional arrangement example 1. In other words, sound pickup device 10 employing three-dimensional arrangement example 3 can generate a main signal having a directivity in a target sound direction (90° direction).

(Sensitivity Characteristic of Reference Signal 2)

In FIG. 6 and FIG. 7, sensitivity characteristics in a direction along the XZ plane have been described, whereas sensitivity characteristics in a direction along the XY plane will be described below. FIG. 14 is a diagram illustrating sensitivity characteristics, in the direction along the XY plane, of reference signals that are generated by sound pickup device 10 employing three-dimensional arrangement example 1. FIG. 15 is a diagram illustrating sensitivity characteristics, in the direction along the XY plane, of 25 reference signals that are generated by sound pickup device 10 employing the planar arrangement example. FIG. 16 is a diagram for describing a method for calculating sensitivity characteristics shown in FIG. 14 and FIG. 15. In FIG. 16, the unit of the numerical values shown on the X-axis, the Y-axis, 30 and the Z-axis is meter.

In FIG. 14 and FIG. 15, the sensitivity characteristics of the reference signals are shown in the same format as those in FIG. 6 and FIG. 7. Here, as illustrated by white circles in FIG. 16, a 90° direction is the positive Y-axis direction, and 35 a 60° direction is a direction shifted by 30° from the positive Y-axis direction along the XY plane. A 30° direction is a direction shifted by 60° from the positive Y-axis direction along the XY plane. It should be noted that, as illustrated by a broken line in FIG. 16, the sensitivity characteristics 40 shown in FIG. 14 and FIG. 15 are sensitivity characteristics for a sound at a position (illustrated by the broken line in FIG. 16) 1.5 m away from microphone array 20 (a collection of microphone elements 20a to 20d).

As described above with reference to FIG. 4 and FIG. 5, 45 only the position of microphone element 20d is different between three-dimensional arrangement example 1 and the planar arrangement example. Accordingly, as shown in the three columns in the right half of each of FIG. 14 and FIG. 15, sensitivity characteristics achieved by microphone pairs 50 each of which is a different combination of two of microphone elements 20a to 20c are not different between three-dimensional arrangement example 1 and the planar arrangement example.

Moreover, as shown in the three columns in the left half 55 of each of FIG. 14 and FIG. 15, sensitivity characteristics of microphone pairs each of which includes microphone element 20d are similar between three-dimensional arrangement example 1 and the planar arrangement example. Accordingly, it can be said that even when microphone 60 elements 20a to 20d are arranged three-dimensionally in a distributed manner, variations of sensitivity characteristics of reference signals are not decreased as compared to when microphone elements 20a to 20d are arranged on the same plane. In other words, it can be said that when microphone 65 elements 20a to 20d are arranged three-dimensionally in a distributed manner, performance of microphone elements

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20a to 20d is not deteriorated as compared to when microphone elements 20a to 20d are arranged on the same plane.

Here, the inventors have checked how sensitivity characteristics of reference signals are changed by adjusting the position of microphone element 20d in three-dimensional arrangement example 1. Specifically, the inventors have calculated sensitivity characteristics of reference signals in three-dimensional arrangement example 4 and three-dimensional arrangement example 5 below.

First, three-dimensional arrangement example 4 will be described. FIG. 17 is a diagram illustrating three-dimensional arrangement example 4 of microphone elements 20a to 20d. FIG. 18 is a diagram illustrating sensitivity characteristics, in the direction along the XY plane, of reference signals that are generated by sound pickup device 10 employing three-dimensional arrangement example 4.

In three-dimensional arrangement example 4 in FIG. 17, the arrangement of microphone elements 20a to 20c is the same as that in three-dimensional arrangement example 1. The position of microphone element 20d is shifted in both the Y-axis direction and the Z-axis direction from the position of microphone element 20d in three-dimensional arrangement example 1. It should be noted that, the position of microphone element 20d does not overlap with any positions of microphone elements 20a to 20c, as viewed from the Z-axis direction. In other words, microphone element 20d is not located directly above any of microphone elements 20a to 20c.

Only the position of microphone element 20d is different between three-dimensional arrangement example 1 and three-dimensional arrangement example 4. Accordingly, as shown in the three columns in the right half of each of FIG. 14 and FIG. 18, sensitivity characteristics achieved by microphone pairs each of which is a different combination of two of microphone elements 20a to 20c are not different between three-dimensional arrangement example 1 and three-dimensional arrangement example 4.

In contrast, as shown in the three columns in the left half of each of FIG. 14 and FIG. 18, sensitivity characteristics of microphone pairs each of which includes microphone element 20d are significantly different between three-dimensional arrangement example 1 and three-dimensional arrangement example 4. In other words, variations of sensitivity characteristics of reference signals can be differentiated by changing the position of microphone element 20d.

Next, three-dimensional arrangement example 5 will be described. FIG. 19 is a diagram illustrating three-dimensional arrangement example 5 of microphone elements 20a to 20d. FIG. is a diagram illustrating sensitivity characteristics, in the direction along the XY plane, of reference signals that are generated by sound pickup device 10 employing three-dimensional arrangement example 5.

In three-dimensional arrangement example 5 in FIG. 19, the arrangement of microphone elements 20a and 20d is the same as that in three-dimensional arrangement example 1. In three-dimensional arrangement example 5, a space between microphone element 20b and microphone element 20c is wider than that in three-dimensional arrangement example 1. Specifically, microphone element 20b is located on the negative side of the X-axis direction with respect to the position of microphone element 20b in three-dimensional arrangement example 1, and microphone element 20c is located on the positive side of the X-axis direction with respect to the position of microphone element 20c in three-dimensional arrangement example 1.

The positions of microphone elements 20b and 20c are different between three-dimensional arrangement example 1

and three-dimensional arrangement example 5. Accordingly, as shown in the leftmost column in each of FIG. 14 and FIG. 20, sensitivity characteristics achieved by a microphone pair which is a combination of microphone element 20a and microphone element 20d are not different between three- 5 dimensional arrangement example 1 and three-dimensional arrangement example 5.

In contrast, as shown in the five columns except for the leftmost column in each of FIG. 14 and FIG. 20, sensitivity characteristics of microphone pairs each of which includes 10 at least microphone element 20b or microphone element 20care different between three-dimensional arrangement example 1 and three-dimensional arrangement example 5. Accordingly, variations of sensitivity characteristics of reference signals can be differentiated by changing the posi- 15 tions of microphone elements 20b and 20c.

(Frequency Response of Main Signal 2)

Next, frequency responses, in the direction along the XY plane, of main signals that are each generated by sound pickup device 10 employing one of the planar arrangement 20 example, three-dimensional arrangement example 1, threedimensional arrangement example 4, and three-dimensional arrangement example 5 will be described. FIG. 21 is a diagram illustrating frequency responses of a main signal planar arrangement example and of which the target sound direction is the 90° direction along the XY plane. FIG. 22 is a diagram illustrating frequency responses of a main signal that is generated by sound pickup device 10 employing three-dimensional arrangement example 1 and of which the 30 target sound direction is the 90° direction along the XY plane. FIG. 23 is a diagram illustrating frequency responses of a main signal that is generated by sound pickup device 10 employing three-dimensional arrangement example 4 and of which the target sound direction is the 90° direction along 35 the XY plane. FIG. 24 is a diagram illustrating frequency responses of a main signal that is generated by sound pickup device 10 employing three-dimensional arrangement example 5 and of which the target sound direction is the 90° direction along the XY plane.

In each of FIG. 21 to FIG. 24, a frequency response in the 90° direction, a frequency response in the 30° direction, and a frequency response in the 0° direction of the main signal are illustrated, and the target sound direction of the main signal is the 90° direction. In each of FIG. 21 to FIG. 24, the 45 vertical axis indicates sound pressure level and the horizontal axis indicates frequency.

In comparison between FIG. 21 (planar arrangement example) and FIG. 22 (three-dimensional arrangement example 1), it can be said that the frequency response in the 50 90° direction, the frequency response in the 30° direction, and the frequency response in the 0° direction of the main signal when three-dimensional arrangement example 1 is employed are similar to those when the planar arrangement example is employed.

In comparison between FIG. 22 (three-dimensional arrangement example 1) and FIG. 23 (three-dimensional arrangement example 4), it can be said that the frequency response in the 90° direction and the frequency response in the 30° direction of the main signal when three-dimensional 60 arrangement example 4 is employed are similar to those when three-dimensional arrangement example 1 is employed. In contrast, a reduction amount of the sound pressure level in the 0° direction at a frequency band of 7 kHz or more when three-dimensional arrangement example 65 4 is employed is decreased as compared to when threedimensional arrangement example 1 is employed.

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In comparison between FIG. 22 (three-dimensional arrangement example 1) and FIG. 24 (three-dimensional arrangement example 5), it can be said that the frequency response in the 90° direction of the main signal when three-dimensional arrangement example 5 is employed is similar to that when three-dimensional arrangement example 1 is employed.

In contrast, a reduction amount of the sound pressure level in the 30° direction at a frequency band of 4 kHz or more when three-dimensional arrangement example 5 is employed is increased as compared to when three-dimensional arrangement example 1 is employed. However, although a reduction amount of the sound pressure level in the 0° direction at a frequency band of from 4 kHz to 5 kHz when three-dimensional arrangement example 5 is employed is increased as compared to when three-dimensional arrangement example 1 is employed, a reduction amount of the sound pressure level in the 0° direction at a frequency band of 7 kHz or more when three-dimensional arrangement example 5 is employed is decreased as compared to when three-dimensional arrangement example 1 is employed.

Thus, sound pickup device 10 employing any of threethat is generated by sound pickup device 10 employing the 25 dimensional arrangement example 1, three-dimensional arrangement example 4, and three-dimensional arrangement example 5 can generate a main signal having a directivity in a target sound direction (90° direction).

(Summary of Three-Dimensional Arrangement)

In each of three-dimensional arrangement examples 1 to 5, any one of straight lines each of which connects two microphone elements of a different one of effective microphone pairs is not parallel to any other of the straight lines. When explained with vectors, vi=t·vi (t is a real number) is not established, where vi and vj (i and j each being a natural number) represent any two of vectors of straight lines each of which connects two microphone elements of a different one of the effective microphone pairs.

Specifically, in each of three-dimensional arrangement 40 examples 1 to 5, the positions of microphone elements 20a to 20d correspond to the positions of the vertices of a tetrahedron (triangular pyramid), and six sides of the tetrahedron corresponding to straight lines (line segments) each of which connects two microphone elements of a different one of the effective microphone pairs (straight lines L1 to L6 in three-dimensional arrangement example 1) are not parallel to one another. In such sound pickup device 10 employing any of three-dimensional arrangement examples 1 to 5, variations of sensitivity characteristics of reference signals are increased.

It should be noted that, in each of three-dimensional arrangement examples 1 to 5, microphone elements 20a to 20d include three microphone elements 20a to 20c that are located on the same plane and one microphone element 20d 55 that is not located on the same plane, and three microphone elements 20a to 20c are arranged to form a triangle on the

Moreover, in each of three-dimensional arrangement examples 2 to 5, one of distances each of which is the distance between two microphone elements of a different one of the effective microphone pairs is different from at least another one of the distances. In other words, in each of three-dimensional arrangement examples 2 to 5, distances between microphone elements are partially irregular. Thus, the directivity of a main signal can be made sharp. According to the consideration by the inventors, the directivity of a main signal can be made sharp in both a low frequency

band and a high frequency band by making a distance between any two microphone elements longer.

(Variations of Three-Dimensional Arrangement)

Here, a three-dimensional arrangement employed in sound pickup device 10 is not limited to three-dimensional arrangement examples 1 to 5. For example, four or more microphone elements included in sound pickup device 10 may include n (n being a natural number greater than or equal to 3) microphone elements that are located on the same plane and one or more microphone elements that are not located on the same plane. For example, microphone elements may be arranged at the vertices of a pyramid whose base is an n-sided polygon.

In this case, the base may be a regular n-sided polygon (n being an odd number) or may be a polygon whose n sides are not parallel to one another. FIG. **25** is a diagram illustrating an example where microphone elements are arranged at the vertices of a quadrangular pyramid whose base is a quadrangle having four sides that are not parallel to one another. 20 In FIG. **25**, the positions of microphone elements are indicated by black circles.

Moreover, microphone elements may be arranged at the apex and the circumference of the bottom of a cone. FIG. **26** is a diagram illustrating an example where microphone ²⁵ elements are arranged at the apex and the circumference of the bottom of a cone. In FIG. **26**, the positions of microphone elements are indicated by black circles. It should be noted that the bottom of the cone may be either a perfect circle or an ellipse.

Moreover, microphone elements may be arranged spirally. Microphone elements may be arranged in any way in a range satisfying the condition that any one of straight lines each of which connects two microphone elements of a different one of effective microphone pairs is not parallel to any other of the straight lines.

(Advantageous Effects, Etc.)

As described above, sound pickup device 10 includes microphone elements 20a to 20d arranged three-dimensionally in a distributed manner. Among microphone pairs each of which is a different combination of two microphone elements of microphone elements 20a to 20d, a total number of effective microphone pairs is greater than a total number of microphone elements 20a to 20d, the effective microphone pairs each being a combination of two microphone elements having a distance less than a distance D between each other.

Distance D is represented by D=c/2f, where f represents a frequency of a target sound obtained from microphone 50 elements 20a to 20d and c represents a velocity of the target sound. Any one of straight lines each of which connects two microphone elements of a different one of the effective microphone pairs is not parallel to any other of the straight lines.

Accordingly, variations of sensitivity characteristics of reference signals are increased, and thus sound pickup device 10 can reduce noise from various directions. In other words, sound pickup device 10 can effectively reduce sound other than a target sound.

Moreover, for example, microphone elements 20a to 20d include n (n being a natural number greater than or equal to 3) microphone elements that are arranged on a same plane and one or more microphone elements that are not arranged on the same plane.

Accordingly, variations of sensitivity characteristics of reference signals can be increased by employing an arrange16

ment in which microphone elements **20***a* to **20***d* are arranged to form an n-sided pyramid (pyramid whose bottom is an n-sided polygon).

Moreover, for example, the n microphone elements are arranged to form a regular n-sided polygon on the same plane.

Accordingly, variations of sensitivity characteristics of reference signals can be increased by employing an arrangement in which microphone elements 20a to 20d are arranged to form a pyramid whose bottom is a regular n-sided polygon.

Moreover, for example, one of distances each of which is the distance between the two microphone elements of a different one of the effective microphone pairs is different from at least another one of the distances.

Accordingly, the directivity of a main signal can be made sharp.

Moreover, for example, the total number of the microphone pairs obtainable from microphone elements 20a to 20d is equal to the total number of the effective microphone pairs.

Accordingly, sound pickup device 10 can effectively reduce sound other than a target sound since all microphone pairs function as effective microphone pairs.

Moreover, for example, sound pickup device 10 further includes: delayers 31a to 31d that delay sound signals obtained from microphone elements 20a to 20d, respectively; main signal generator 31 that generates main signal X_m by adding up output signals from delayers 31a to 31d; reference signal generators 32a to 32f that generate reference signals X_{r1} to X_{r6} , respectively, by performing subtraction between each pair of output signals corresponding to combinations of two microphone elements of the effective microphone pairs, among the output signals from delayers 31a to 31d; adaptive filters 33a to 33f that apply filter coefficients to reference signals X_{r1} to X_{r6} , respectively; subtractor ${\bf 34}$ that subtracts, from main signal ${\bf X}_m$ generated, reference signals X_{r1} to X_{r6} to which the filter coefficients have been applied; and coefficient updater 35 that updates the filter coefficients, based on output signal Y obtained by the subtraction by subtractor 34.

Delayers 31a to 31d are an example of a delayer. Main signal X_m is an example of a first signal, and is a signal that is generated by adding up sound signals (output signals from delayers 31a to 31d) that have been obtained from microphone elements 20a to 20d and delayed by delayers 31a to **31***d*, respectively, according to a target sound direction. Each of reference signals X_{r1} to X_{r6} is an example of a second signal, and a signal that is generated by performing subtraction between two sound signals (among output signals from delayers 31a to 31d) that have been obtained from two microphone elements of a corresponding one of the effective microphone pairs and delayed by corresponding two of delayers 31a to 31d according to the target sound direction. Main signal generator 31 is an example of a first signal generator, each of reference signal generators 32a to 32f is an example of a second signal generator, and output signal Y is an example of a third signal.

Accordingly, sound pickup device 10 can perform beamforming based on sound signals obtained from microphone elements 20a to 20d.

OTHER EMBODIMENTS

Although the embodiment has been described thus far, the present disclosure is not limited to the embodiment.

For example, the shape or the like of the sound pickup device described in the embodiment is an example, and the sound pickup device may be in the shape of cuboid or other shape.

Moreover, the configuration of the signal processor 5 according to the embodiment is an example. For example, the signal processor may include a D/A converter, a low pass filter (LPF), a high pass filter (HPF), a power amplifier, or an A/D converter, as a constituent element. Moreover, although signal processing performed by the signal processor is digital signal processing for example, part of the signal processing may be analog signal processing.

Furthermore, in the embodiment, the signal processor may be configured of dedicated hardware, or may be implemented by executing a software program suitable for the 15 signal processor. The signal processor may be implemented by a program executor, such as a CPU or a processor, retrieving and executing a software program stored in a storage medium, such as a hard disk drive or a semiconductor memory device.

Moreover, the signal processor may be circuits (or an integrated circuit). These circuits may be configured as a single circuit or may be individual circuits. Moreover, these circuits may be ordinary circuits or specialized circuits.

Furthermore, although the signal processor is imple- 25 mented as hardware (circuit) in the embodiment, part or all of the signal processor may be implemented by executing a software program suitable for the signal processor. The signal processor may be implemented by a program executor, such as a CPU or a processor, retrieving and executing 30 a software program stored in a storage medium, such as a hard disk drive or a semiconductor memory device.

Additionally, forms obtained by making various modifications to the embodiment that can be conceived by a person skilled in the art, as well as other forms realized by arbitrarily combining some constituent elements and functions in the embodiment, without departing from the essence of the present disclosure, are included in the scope of the present disclosure. For example, the present disclosure may be implemented as a system including a sound pickup device 40 according to the embodiment.

INDUSTRIAL APPLICABILITY

A sound pickup device according to the present disclosure $_{45}$ is applicable as a sound pickup device used in a teleconference system or the like.

The invention claimed is:

- 1. A sound pickup device comprising:
- a plurality of microphone elements that are arranged 50 three-dimensionally in a distributed manner, wherein among microphone pairs each of which is a different combination of two microphone elements of the plu-

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rality of microphone elements, a total number of effective microphone pairs is greater than a total number of the plurality of microphone elements, the effective microphone pairs each being a combination of two microphone elements having a distance less than a distance D between each other.

the distance D is represented by D=c/2f, where f represents a frequency of a target sound obtained from the plurality of microphone elements and c represents a velocity of the target sound,

any one of straight lines each of which connects the two microphone elements of a different one of the effective microphone pairs is not parallel to any other of the straight lines, and

the plurality of microphone elements include n microphone elements that are located on a same plane and one or more microphone elements that are not located on the same plane, n being a natural number greater than or equal to 3.

- 2. The sound pickup device according to claim 1, wherein the n microphone elements are arranged to form a regular n-sided polygon on the same plane.
- 3. The sound pickup device according to claim 1, wherein one of distances each of which is the distance between the two microphone elements of a different one of the effective microphone pairs is different from at least another one of the distances.
- 4. The sound pickup device according to claim 1, wherein a total number of the microphone pairs obtainable from the plurality of microphone elements is equal to the total number of the effective microphone pairs.
- 5. The sound pickup device according to claim 1, further comprising:
 - a delayer that individually delays sound signals obtained from the plurality of microphone elements;
 - a first signal generator that generates a first signal by adding up output signals from the delayer;
 - a second signal generator that generates a second signal by performing subtraction between two output signals corresponding to the two microphone elements of one of the effective microphone pairs, among the output signals from the delayer;
 - an adaptive filter that applies a filter coefficient to the second signal;
 - a subtractor that subtracts, from the first signal generated, the second signal to which the filter coefficient has been applied; and
 - a coefficient updater that updates the filter coefficient, based on a third signal obtained by the subtraction performed by the subtractor.

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